



Power MOSFETS

DATASHEET

LM30036NAO2A

N-Channel
Enhancement Mode MOSFET

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Quality Management Systems
ISO 9001:2015 Certificate

LM30036NAO2A

N-Channel Enhancement Mode MOSFET

Pin Description

TO-252-2L (TOP view)	Symbol	Symbol	N-Channel	Unit
		V_{DSS}	30	V
		$R_{DS(ON)-Max}$	5.2	$m\Omega$
		I_D	102	A

Feature

- Fast switching speed
- Reliable and Rugged
- ROHS Compliant & Halogen-Free
- 100% UIS and Rg Tested

Ordering Information

Ordering Information

Orderable Part Number	Package Type	Form	Shipping	Marking
LM30036NAO2A	TO-252-2L	Tape & Reel	3000 / Tape & Reel	30036 <input type="checkbox"/> <input type="checkbox"/> <input type="checkbox"/> <input type="checkbox"/> <input type="checkbox"/>

Note : = Lot Code

Absolute Maximum Ratings ($T_J=25^\circ C$ Unless Otherwise Noted)

Symbol	Parameter	N-Channel	Unit
V_{DSS}	Drain-Source Voltage	30	V
V_{GSS}	Gate-Source Voltage	± 20	
T_J	Maximum Junction Temperature	150	$^\circ C$
T_{STG}	Storage Temperature Range	-55 to 150	$^\circ C$
$I_{DM}^{(1)}$	Pulse Drain Current Tested	$T_c=25^\circ C$	A
I_D	Continuous Drain Current	$T_c=25^\circ C$	$84.3^{(1)}$
		$T_c=100^\circ C$	53.3
P_D	Maximum Power Dissipation	$T_c=25^\circ C$	54.3
		$T_c=100^\circ C$	21.7
I_D	Continuous Drain Current	$T_A=25^\circ C$	16.2
		$T_A=70^\circ C$	13
P_D	Maximum Power Dissipation	$T_A=25^\circ C$	2
		$T_A=70^\circ C$	1.3
$I_{AS}^{(2)}$	Avalanche Current, Single pulse	$L=0.1mH$	31
		$L=0.5mH$	21
$E_{AS}^{(2)}$	Avalanche Energy, Single pulse	$L=0.1mH$	49
		$L=0.5mH$	110

Thermal Characteristics

Symbol	Parameter	Rating	Unit
$R_{\theta JC}$	Thermal Resistance-Junction to Case	Steady State	$^\circ C/W$
$R_{\theta JA}^{(3)}$	Thermal Resistance-Junction to Ambient	Steady State	$^\circ C/W$

Note ① : Max. current is limited by bonding wire .

Note ② : UIS tested and pulse width are limited by maximum junction temperature $150^\circ C$

Note ③ : Surface Mounted on 1in² FR-4 board with 1oz

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N-Channel Electrical Characteristics ($T_J=25^\circ\text{C}$ Unless Otherwise Noted)

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Unit
Static Electrical Characteristics						
BV_{DSS}	Drain-Source Breakdown Voltage	$V_{\text{GS}}=0\text{V}, I_{\text{DS}}=250\mu\text{A}$	30	-	-	V
I_{DSS}	Zero Gate Voltage Drain Current	$V_{\text{DS}}=24\text{V}, V_{\text{GS}}=0\text{V}$	-	-	1	μA
$V_{\text{GS(th)}}$	Gate Threshold Voltage	$V_{\text{DS}}=V_{\text{GS}}, I_{\text{DS}}=250\mu\text{A}$	1	1.5	2	V
I_{GSS}	Gate Leakage Current	$V_{\text{GS}}=\pm 20\text{V}, V_{\text{DS}}=0\text{V}$	-	-	± 100	nA
$R_{\text{DS(ON)}}^{\text{(4)}}$	Drain-Source On-state Resistance	$V_{\text{GS}}=10\text{V}, I_{\text{DS}}=20\text{A}$	-	4	5.2	$\text{m}\Omega$
		$V_{\text{GS}}=4.5\text{V}, I_{\text{DS}}=10\text{A}$	-	5	6.4	
g_{fs}	Forward Transconductance	$V_{\text{DS}}=5\text{V}, I_{\text{DS}}=20\text{A}$	-	22	-	S
Dynamic Characteristics ⁽⁵⁾						
R_{G}	Gate Resistance	$V_{\text{GS}}=0\text{V}, V_{\text{DS}}=0\text{V},$ $\text{Freq.}=1\text{MHz}$	-	1.0	-	Ω
C_{iss}	Input Capacitance	$V_{\text{GS}}=0\text{V},$ $V_{\text{DS}}=15\text{V},$ $\text{Freq.}=1\text{MHz}$	-	2432	-	pF
C_{oss}	Output Capacitance		-	308	-	
C_{rss}	Reverse Transfer Capacitance		-	258	-	
$t_{\text{d(ON)}}$	Turn-on Delay Time	$V_{\text{GS}}=10\text{V}, V_{\text{DS}}=15\text{V},$ $I_{\text{D}}=1\text{A}, R_{\text{GEN}}=3\Omega$	-	10.2	-	nS
t_{r}	Turn-on Rise Time		-	17.6	-	
$t_{\text{d(OFF)}}$	Turn-off Delay Time		-	43.2	-	
t_{f}	Turn-off Fall Time		-	31.7	-	
Q_{g}	Total Gate Charge	$V_{\text{GS}}=4.5\text{V}, V_{\text{DS}}=15\text{V}$ $I_{\text{D}}=20\text{A}$	-	33.1	-	nC
Q_{g}	Total Gate Charge	$V_{\text{GS}}=10\text{V}, V_{\text{DS}}=15\text{V},$ $I_{\text{D}}=20\text{A}$	-	62.0	-	
Q_{gs}	Gate-Source Charge		-	10.2	-	
Q_{gd}	Gate-Drain Charge		-	16.01	-	
Source-Drain Characteristics						
$V_{\text{SD}}^{\text{(4)}}$	Diode Forward Voltage	$I_{\text{SD}}=1\text{A}, V_{\text{GS}}=0\text{V}$	-	0.7	1.1	V
t_{rr}	Reverse Recovery Time	$I_{\text{F}}=1\text{A}, V_{\text{GS}}=0$	-	20	-	nS
Q_{rr}	Reverse Recovery Charge	$dI_{\text{F}}/dt=100\text{A}/\mu\text{s}$	-	12.1	-	nC

Note ⁽⁴⁾ : Pulse test (pulse width $\leq 300\text{us}$, duty cycle $\leq 2\%$).

Note ⁽⁵⁾ : Guaranteed by design, not subject to production testing.

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N-Channel Typical Characteristics

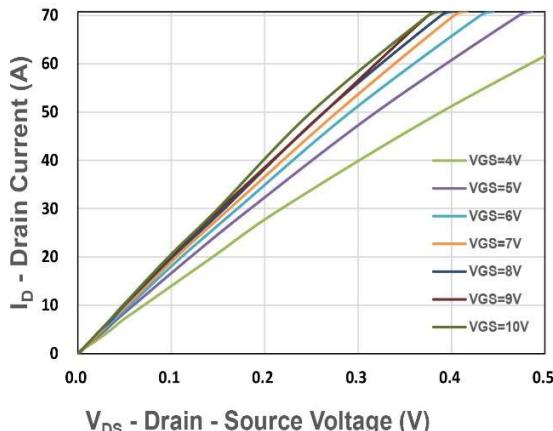


Figure 1. Output Characteristics

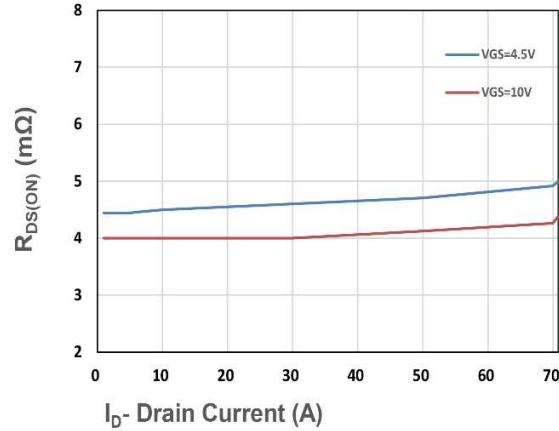


Figure 2. On-Resistance vs. ID

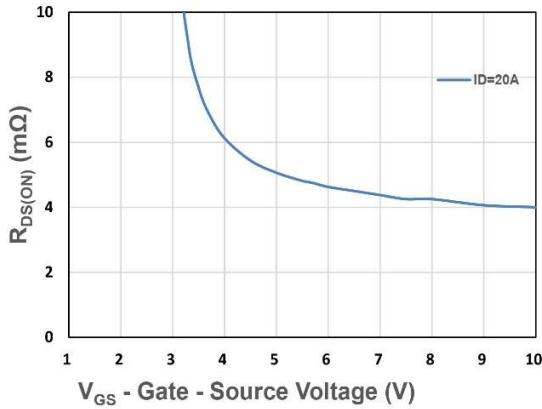


Figure 3. On-Resistance vs. VGS

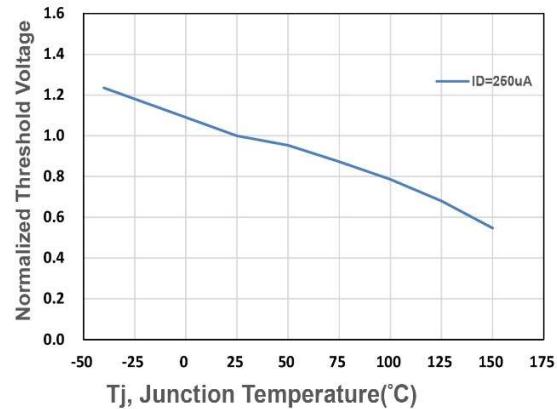


Figure 4. Gate Threshold Voltage

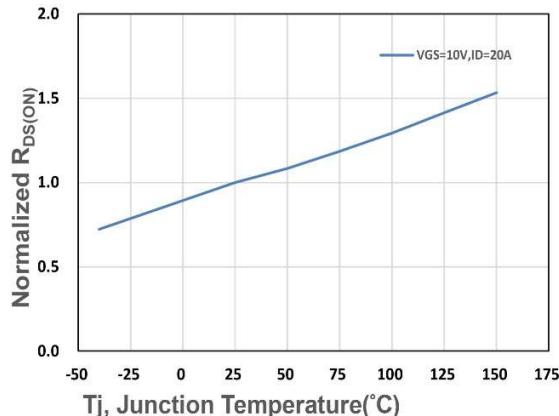


Figure 5. Drain-Source On Resistance

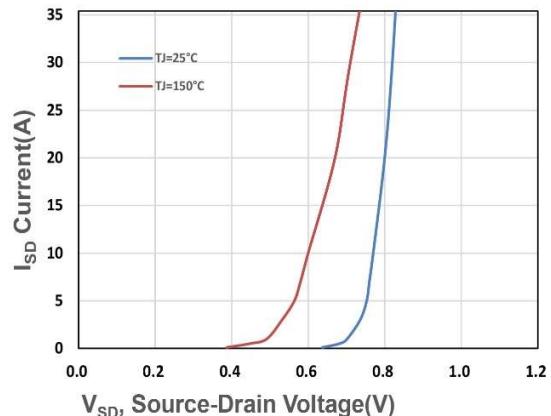


Figure 6. Source-Drain Diode Forward

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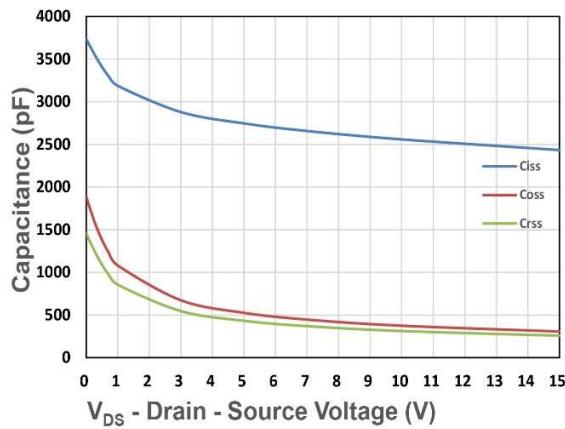


Figure 7. Capacitance

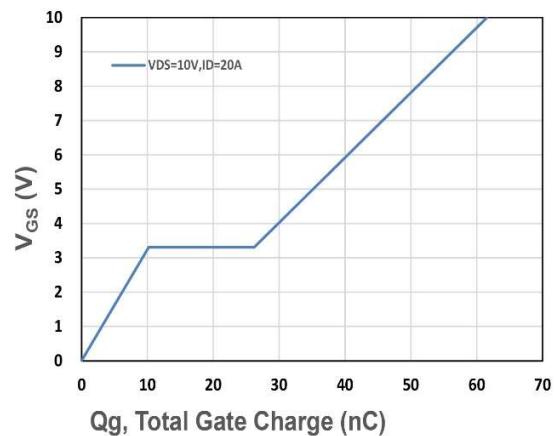


Figure 8. Gate Charge Characteristics

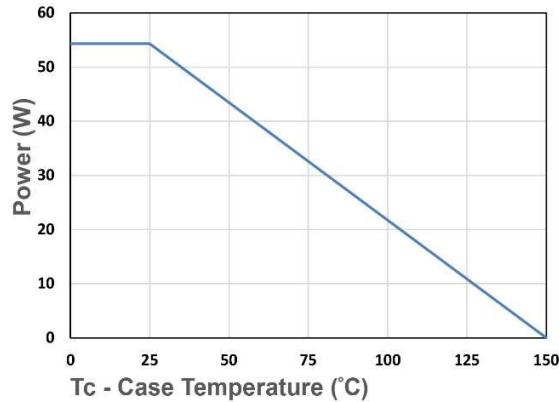


Figure 9. Power Dissipation

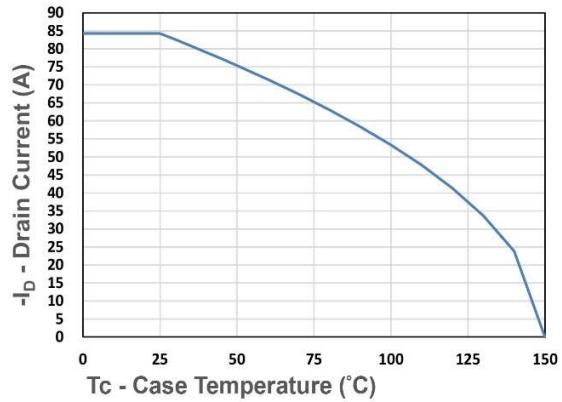


Figure 10. Drain Current

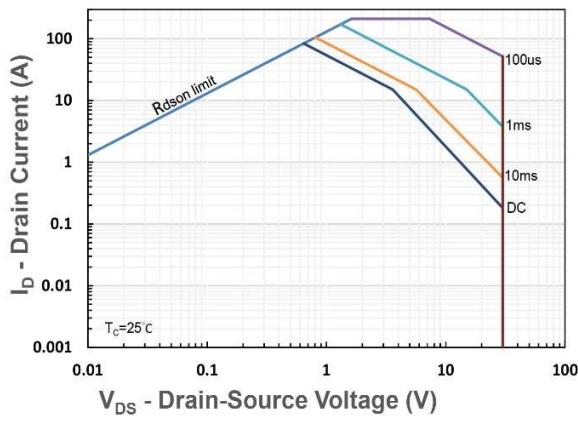


Figure 11. Safe Operating Area

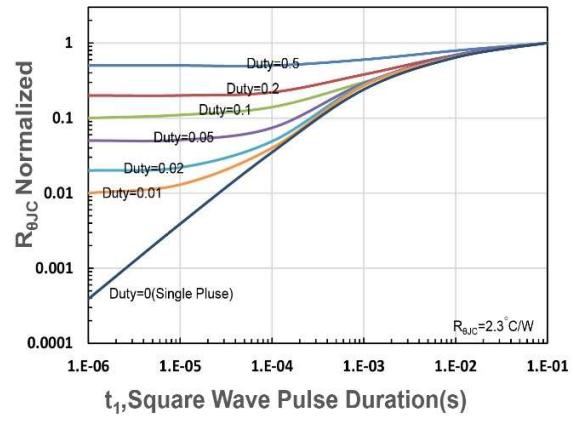


Figure 12. R_{JJC} Transient Thermal Impedance